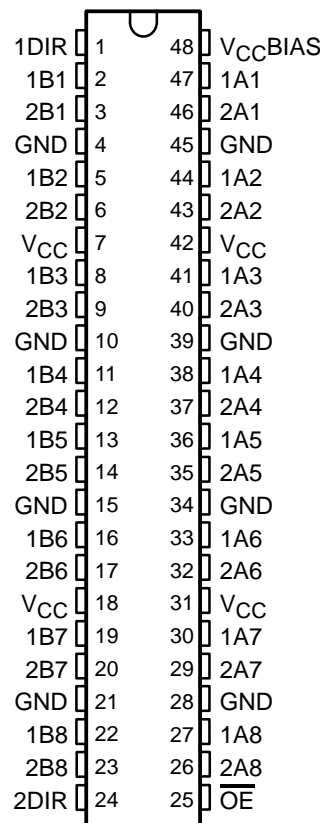


SN54ABTE16245, SN74ABTE16245 16-BIT INCIDENT-WAVE SWITCHING BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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- Support the VME64 ETL Specification
- Reduced, TTL-Compatible, Input Threshold Range
- High-Drive Outputs ($I_{OH} = -60$ mA, $I_{OL} = 90$ mA) Support 25- Ω Incident-Wave Switching
- V_{CCBIAS} Pin Minimizes Signal Distortion During Live Insertion
- Internal Pullup Resistor on \overline{OE} Keeps Outputs in High-Impedance State During Power Up or Power Down
- Members of the Texas Instruments (TI) *Widebus*™ Family
- State-of-the-Art *EPIC-II B*™ BiCMOS Design Significantly Reduces Power Dissipation
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- 25- Ω Series Damping Resistor on B Port
- Bus Hold on Data Inputs Eliminates the Need for External Pullup Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-Mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center Spacings

SN54ABTE16245 . . . WD PACKAGE
SN74ABTE16245 . . . DGG OR DL PACKAGE
(TOP VIEW)



description

The 'ABTE16245 are 16-bit (dual-octal) noninverting 3-state transceivers designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements. These devices can be used as two 8-bit transceivers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so that the buses are effectively isolated. When \overline{OE} is low, the device is active.

The B port has a 25- Ω series output resistor to reduce ringing. Active bus-hold inputs are also found on the B port to hold unused or floating inputs at a valid logic level.

The A port provides for the precharging of the outputs via V_{CCBIAS} , which establishes a voltage between 1.3 V and 1.7 V when V_{CC} is not connected.

The SN74ABTE16245 is available in TI's shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ABTE16245 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABTE16245 is characterized for operation from -40°C to 85°C .



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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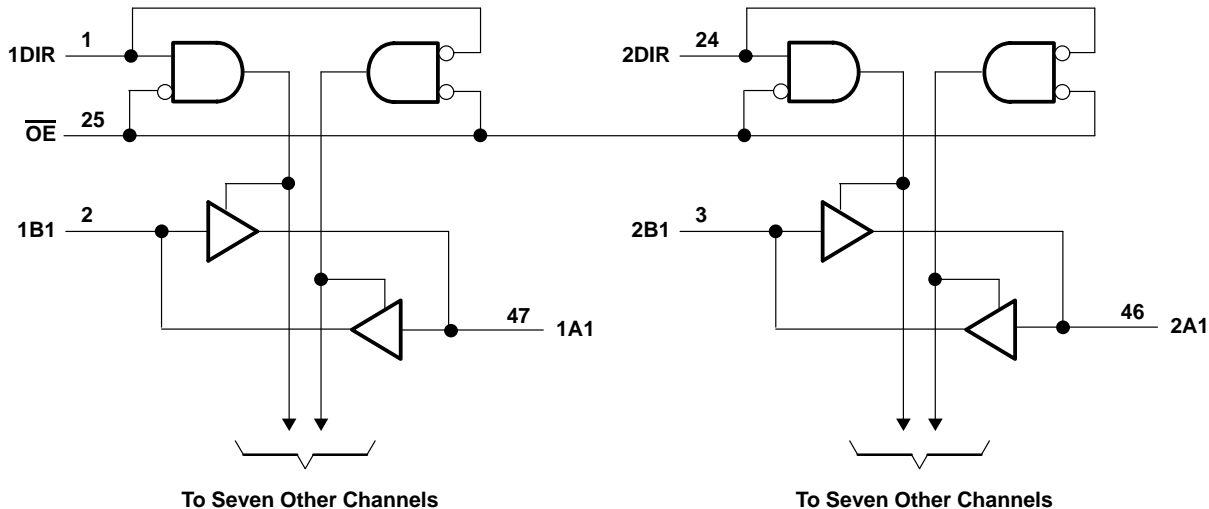
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FUNCTION TABLE

INPUTS		OPERATION
\overline{OE}	DIR	
L	L	A data to B bus
L	H	B data to A bus
H	X	Isolation

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	−0.5 V to 7 V
Input voltage range, V_I (except I/O ports) (see Note 1)	−0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, V_O	−0.5 V to 5.5 V
Current into any output in the low state, I_O	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	−18 mA
Output clamp current, I_{OK} ($V_O < 0$)	−50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): DGG package	0.85 W
DL package	1.2 W
Storage temperature range, T_{stg}	−65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the *ABT Advanced BiCMOS Technology Data Book*.

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recommended operating conditions (see Note 3)

			SN54ABTE16245			SN74ABTE16245			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
V _{IH}	High-level input voltage	\overline{OE}	2			2			V
		Except \overline{OE}	1.6			1.6			
V _{IL}	Low-level input voltage	\overline{OE}			0.8			0.8	V
		Except \overline{OE}			1.4			1.4	
V _I	Input voltage		0		V _{CC}	0		V _{CC}	V
I _{OH}	High-level output current	B bus			–12			–12	mA
		A bus			–24			–60	
I _{OL}	Low-level output current	B bus			12			12	mA
		A bus			64			90	
Δt/Δv	Input transition rise or fall rate	Outputs enabled			10			10	ns/V
T _A	Operating free-air temperature		–55		125	–40		85	°C

NOTE 3: Unused pins (input or A-bus I/O) must be held high or low to prevent them from floating.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54ABTE16245			SN74ABTE16245			UNIT		
				MIN	TYP†	MAX	MIN	TYP†	MAX			
V _{IK}		V _{CC} = 4.5 V, I _I = −18 mA		−1.2			−1.2			V		
V _{OH}	B port	V _{CC} = 5.5 V, I _{OH} = −100 μA		V _{CC} −0.2			V _{CC} −0.2			V		
		V _{CC} = 4.5 V	I _{OH} = −1 mA	2.4		2.4						
			I _{OH} = −12 mA	2		2						
		A port	V _{CC} = 5.5 V, I _{OH} = −1 mA		4.5			4.5				
	V _{CC} = 4.5 V		I _{OH} = −32 mA	2.4		2.4						
			I _{OH} = −64 mA				2					
V _{OL}	B port	V _{CC} = 4.5 V	I _{OL} = 1 mA	0.4			0.4			V		
			I _{OL} = 12 mA				0.8					
	A port	V _{CC} = 4.5 V	I _{OL} = 64 mA	0.55			0.55					
			I _{OL} = 90 mA				0.9					
I _{I(hold)}	B port	V _{CC} = 4.5 V	V _I = 0.8 V	100			100			μA		
			V _I = 2 V	−100			−100					
		V _{CC} = 5.5 V, V _I = 0 to 5.5 V		±500			±500					
I _I	Control inputs	V _{CC} = 5.5 V, V _I = V _{CC} or GND		±1			±1			μA		
	A or B ports	V _{CC} = 5.5 V, V _I = V _{CC} or GND		±20			±20					
I _{OZH} [‡]	A port	V _{CC} = 5.5 V, V _O = 2.7 V		10			10			μA		
I _{OZL} [‡]	A port	V _{CC} = 5.5 V, V _O = 0.5 V		−10			−10			μA		
I _O	A port	V _{CC} = 5.5 V, V _O = 2.5 V		−50	−120	−180	−50		−180	mA		
	B port			−25	−52	−90	−25		−90			
I _{off}		V _{CC} = 0, V _I or V _O ≤ 4.5 V, V _{CCBIAS} = 0		±100			±100			μA		
I _{CC}	A or B ports	V _{CC} = 5.5 V, I _O = 0, V _I = V _{CC} or GND	Outputs high	28		36		28		36		mA
			Outputs low	38		48		38		48		
			Outputs disabled	20		32		20		32		
I _{CCD}	A or B ports	V _{CC} = 5 V, C _L = 50 pF	$\overline{\text{OE}}$ high	0.02				0.02				mA/ MHz
			$\overline{\text{OE}}$ low	0.33				0.33				
C _i	Control inputs	V _I = 2.5 V or 0.5 V			10			2.5			4	pF
C _{io}	I/O ports	V _O = 2.5 V or 0.5 V			13			4.5			8	pF

† All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

‡ The parameters I_{OZH} and I_{OZL} include the input leakage current.

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16-BIT INCIDENT-WAVE SWITCHING BUS TRANSCEIVERS

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live-insertion specifications over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS		SN54ABTE16245			SN74ABTE16245			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
I _{CC} (V _{CCBIAS})		V _{CC} = 0 to 4.5 V, V _{CCBIAS} = 4.5 V to 5.5 V, I _O (DC) = 0		250 700			250 700			μA
		V _{CC} = 4.5 V to 5.5 V‡, V _{CCBIAS} = 4.5 V to 5.5 V, I _O (DC) = 0		20			20			
V _O	A port	V _{CC} = 0	V _{CCBIAS} = 4.5 V to 5.5 V	1.1	1.5	1.9	1.1	1.5	1.9	V
			V _{CCBIAS} = 4.75 V to 5.25 V	1.3	1.5	1.7	1.3	1.5	1.7	
I _O	A port	V _{CC} = 0	V _O = 0, V _{CCBIAS} = 4.5 V	–20		–100	–20		–100	μA
			V _O = 3 V, V _{CCBIAS} = 4.5 V	20		100	20		100	

† All typical values are at $V_{CC} = 5$ V, $T_A = 25^\circ C$.

‡ $V_{CC} - 0.5$ V < V_{CCBIAS}

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5$ V, $T_A = 25^\circ C$			SN54ABTE16245		SN74ABTE16245		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A	B	1.5	3.3	4.2	1.5	5.4	1.5	5.2	ns
t_{PHL}			1.5	3.8	4.6	1.5	5.4	1.5	5.2	
t_{PLH}	B	A	1.5	3	3.8	1.5	4.7	1.5	4.5	ns
t_{PHL}			1.5	3.1	4	1.5	4.7	1.5	4.5	
t_{PZH}	\overline{OE}	A	2	3.9	5.3	2	6.4	2	6.2	ns
t_{PZL}			2	4.4	5.9	2	7	2	6.8	
t_{PZH}	\overline{OE}	B	2	4.5	6	2	7.3	2	7.1	ns
t_{PZL}			2	5	6.4	2	7.5	2	7.3	
t_{PHZ}	\overline{OE}	A	2	4.9	5.9	2	7	2	6.7	ns
t_{PLZ}			2	3.7	4.6	2	5.4	2	5.1	
t_{PHZ}	\overline{OE}	B	2	5.2	6.2	2	7.2	2	7	ns
t_{PLZ}			2	4	5	2	5.8	2	5.5	

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16-BIT INCIDENT-WAVE SWITCHING BUS TRANSCEIVERS

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extended switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Note 4 and Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD	$V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$			SN54ABTE16245		SN74ABTE16245		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	B	A	$R_X = 13\ \Omega$	1.5	3.2	4	1.5	5	1.5	4.8	ns
t_{PHL}				1.5	3.8	4.7	1.5	5.8	1.5	5.6	
t_{PLH}	B	A	$R_X = 26\ \Omega$	1.5	3.1	4	1.5	4.8	1.5	4.6	ns
t_{PHL}				1.5	3.5	4.4	1.5	5.2	1.5	4.9	
t_{PLH}	B	A	$R_X = 56\ \Omega$	1.5	3	3.8	1.5	4.7	1.5	4.5	ns
t_{PHL}				1.5	3.3	4.2	1.5	5.1	1.5	4.7	
$t_{sk(p)}$	B	A	$R_X = \text{Open}$		0.1	0.6		2		2	ns
	A	B			0.4	0.8		2		2	
	B	A	$R_X = 26\ \Omega$		0.3	0.8		2		2	
$t_{sk(o)}$	B	A	$R_X = \text{Open}$		0.3	0.7		1.3		1.3	ns
	A	B			0.7	1.1		1.3		1.3	
	B	A	$R_X = 26\ \Omega$		0.5	1		1.3		1.3	
t_t^\dagger	B	A	$R_X = 26\ \Omega$	0.5	0.8	1.5	0.5	1.5	0.5	1.5	ns
t_t^\ddagger	A	B	Rise or fall time 10%–90%	3.5	5.5	7.3	3.5	8.1	3.5	7.9	ns

$^\dagger t_t$ is measured between 1 V and 2 V of the output waveform.

$^\ddagger t_t$ is measured between 10% and 90% of the output waveform.

NOTE 4: Limits are specified but not tested.

extended output characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (see Note 4 and Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	LOAD	SN54ABTE16245		SN74ABTE16245		UNIT
					MIN	MAX	MIN	MAX	
$t_{sk(temp)}$	A	B	$V_{CC} = \text{Constant},$ $\Delta T_A = 20^\circ\text{C}$			3		2.5	ns
	B	A		$R_X = 56\ \Omega$		4.5		4	
$t_{sk(load)}$	B	B	$V_{CC} = \text{Constant},$ Temperature = Constant	$R_X = 13, 26,$ or $56\ \Omega$		4.5		4	ns

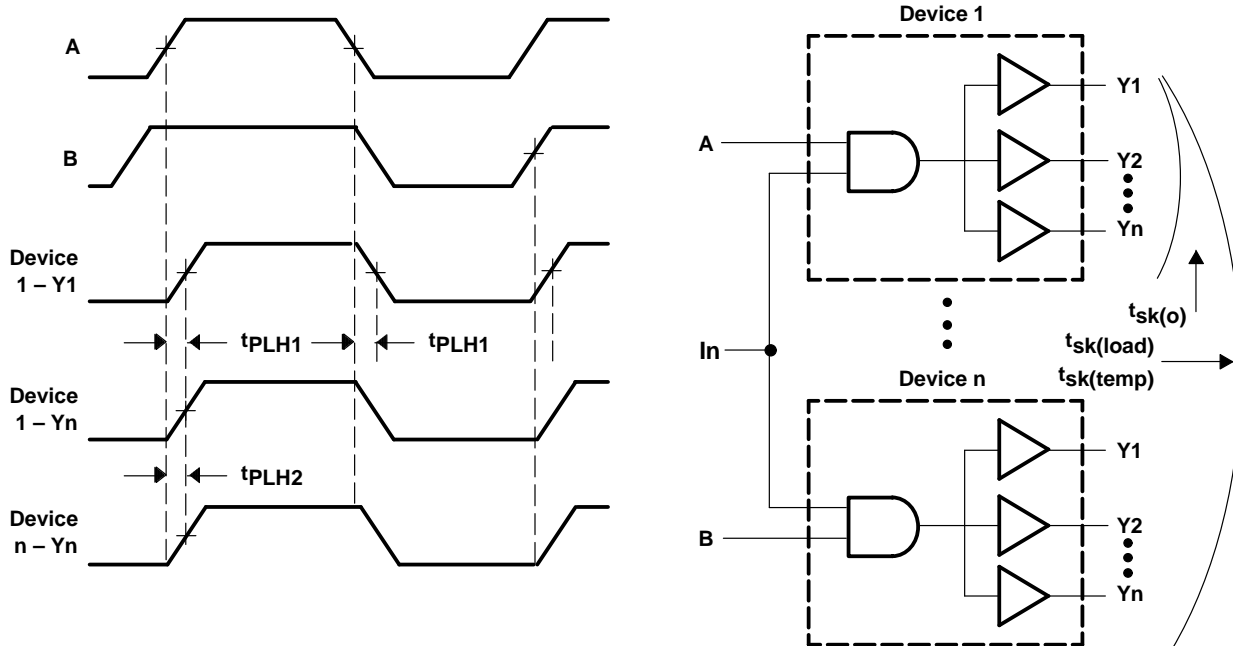
NOTE 4: Limits are specified but not tested.



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PARAMETER MEASUREMENT INFORMATION



- NOTES:
- Pulse skew, $t_{sk(p)}$, is defined as the difference in propagation delay times t_{PLH1} and t_{PHL1} on the same terminal at identical operating conditions.
 - Output skew, $t_{sk(o)}$, is defined as the difference in propagation delay of the fastest and slowest paths on a single device that originate at either a single input or multiple simultaneously switched inputs (e.g., $|t_{PLH1} - t_{PLH2}|$).
 - Temperature skew, $t_{sk(temp)}$, is the output skew of two devices, both having the same value of $V_{CC} \pm 1\%$ and with package temperature differences of 20°C .
 - Load skew, $t_{sk(load)}$, is measured with R_X in Figure 2 at $13\ \Omega$ for one unit and $56\ \Omega$ for the other unit.

Figure 1. Voltage Waveforms for Extended Characteristics

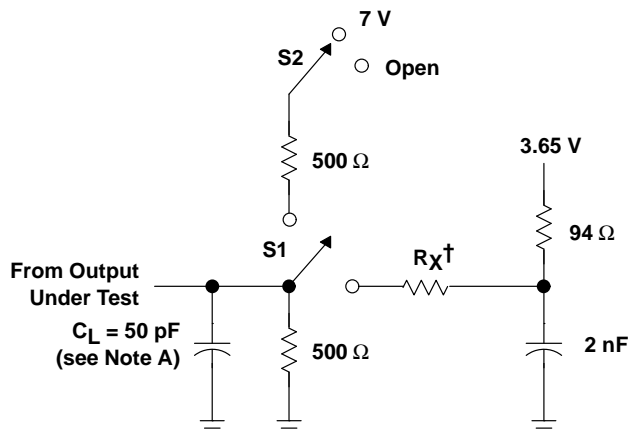
SN54ABTE16245, SN74ABTE16245

16-BIT INCIDENT-WAVE SWITCHING BUS TRANSCEIVERS

WITH 3-STATE OUTPUTS

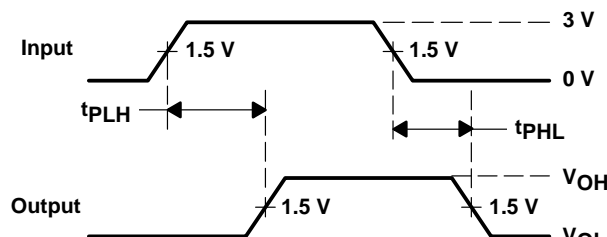
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PARAMETER MEASUREMENT INFORMATION

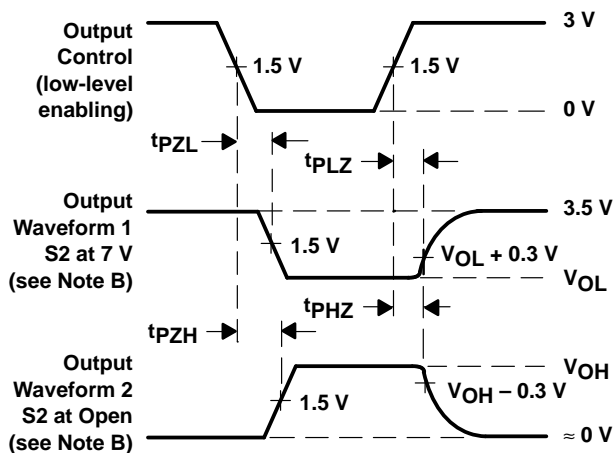


† $R_X = 13, 26, \text{ or } 56 \Omega$

LOAD CIRCUIT FOR OUTPUTS



VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES

SWITCHING TABLE LOADS	S1	S2
t_{PLH}/t_{PHL} (A and B port)	Up	Open
t_{PLZ}/t_{PZL}	Up	7 V
t_{PHZ}/t_{PZH}	Up	Open

EXTENDED SWITCHING TABLE LOADS	S1	S2
$t_{PLH}/t_{PHL}/t_{sk}$ (A port)	Down	X
$t_{PLH}/t_{PHL}/t_{sk}$ (B port)	Up	Open
t_t (A port) (see Note E)	Down	X
t_t (B port) (see Note F)	Up	Open

- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - The outputs are measured one at a time with one transition per measurement.
 - t_t is measured between 1 V and 2 V of the output waveform.
 - t_t is measured between 10% and 90% of the output waveform.

Figure 2. Load Circuit and Voltage Waveforms

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